

1200 Watts • 50 Volts • 32us, 2% L-Band Avionics 1030/1090 MHz

GENERAL DESCRIPTION

The 1011GN-1200V/VEL are internally matched, COMMON SOURCE, class AB, GaN on SiC HEMT transistors capable of providing over 18.5 dB gain, 1200 Watts of pulsed RF output power at 32us, 2% duty cycle pulse format across the 1030 to 1090 MHz band and can also transmit Mode-S ELM pulse format. The transistor has an internal pre-match for optimal performance and uses gold metallization to provide highest reliability and superior ruggedness.

ABSOLUTE MAXIMUM RATINGS

Maximum Power Dissipation

Device Dissipation @ 25°C 2400W

Maximum Voltage and Current

Drain-Source Voltage (V_{DSS}) 150 V Gate-Source Voltage (V_{GS}) -8 to +0 V

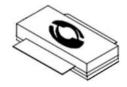
Maximum Temperatures

Storage Temperature (T_{STG}) -55 to +125° C Operating Junction Temperature +200° C

CASE OUTLINES Common Source 55-Q03



55-Q03P



ELECTRICAL CHARACTERISTICS @ 25°C

Symbol	Characteristics	Test Conditions	Min	Тур	Max	Units
P _{IN}	Input Power	P _{OUT} =1200W, Freq=1030,1090 MHz		10.5	15	W
G₽	Power Gain	P _{OUT} =1200W, Freq=1030,1090 MHz	18.5	20		dB
ηD	Drain Efficiency	P _{OUT} =1200W, Freq=1030,1090 MHz		75		%
Dr	Droop	P _{OUT} =1200W, Freq=1030,1090 MHz			0.3	dB
VSWR-T	Load Mismatch Tolerance	P _{OUT} =1200W, Freq= 1030MHz			3:1	
ОJC	Thermal Resistance	32us, 2% duty cycle			0.25	°C/W

• Bias Condition: Vdd=+50V, Idq=150mA average current (Vgs= -2.0 ~ -4.5V typical)

FUNCTIONAL CHARACTERISTICS @ 25°C

I _{D(OFF)}	Drain leakage current	$V_{GS} = -8V, V_D = 150V$		64	mA
I _{G(OFF)}	Gate leakage current	$V_{GS} = -8V$, $V_D = 0V$		20	mA

Export Classification: EAR 99



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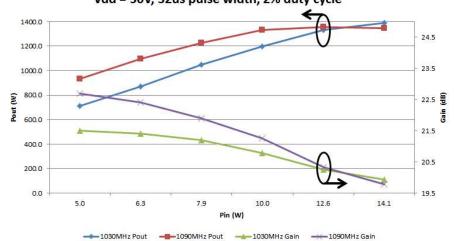
TYPICAL BROAD BAND PERFORMACE DATA

1030 MHz

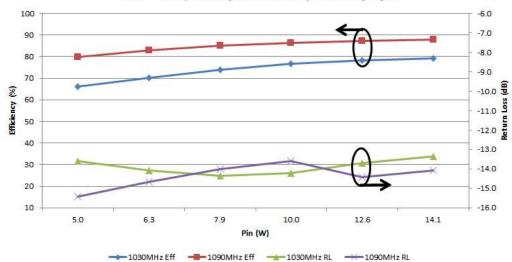
1090 MHz

P _{IN} (W)	P _{OUT} (W)	IRL (dB)	Eff (%)	P _{OUT} (W)	IRL (dB)	Eff (%)
7.9	1045	-14	74	1220	-14	84
10.0	1200	-14	76	1330	-14	86
12.6	1330	-13	78	1360	-14	87
14.1	1390	-13	79	1350	-14	87

1011GN-1200V Vdd = 50V, 32us pulse width, 2% duty cycle



1011GN-1200V Vdd = 50V, 32us pulse width, 2% duty cycl

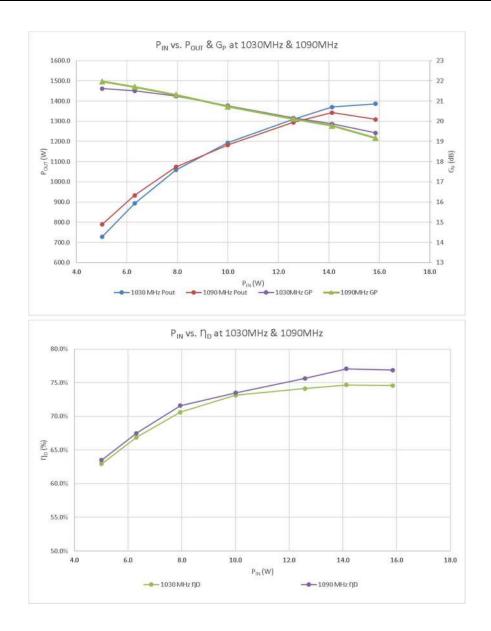




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TYPICAL 1030/1090MHz PERFORMACE DATA – V_{DD}=50V, I_{DQ}=150mA Mode-S ELM Pulsing: 32us ON/18us OFF x48, Long Term Duty Cycle=6.4%

	Pulse 1			Pulse 48				
Freq	P _{IN} (W)	P _{OUT} (W)	G _P (dB)	IRL (dB)	η _□ (%)	Pout(W)	G _P (dB)	Droop
1030 MHz	14.1	1370.9	19.87	-15.5	74.7%	1096.5	18.9	0.97
1090 MHz	14.1	1342.8	19.78	-8.5	77.1%	1096.5	18.9	0.88

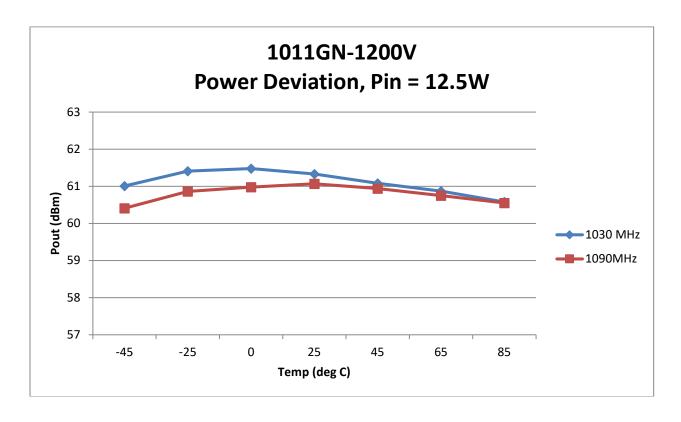




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TYPICAL OVER TEMPERATURE PERFORMANCE

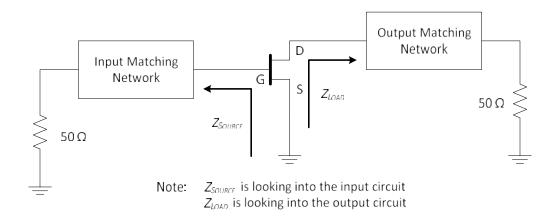
Pulsing=32us-2%, V_{DD}=50V, I_{DQ}=150mA





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TRANSISTOR IMPEDANCE INFORMATION

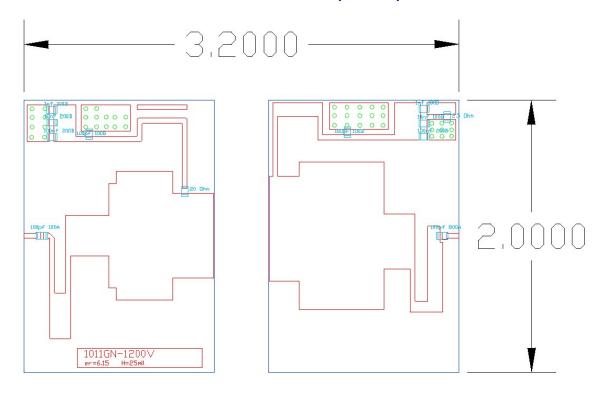


Frequency	Z _{SOURCE}	$Z_{\scriptscriptstyle LOAD}$
1030 MHz	1.32-j0.37 Ω	0.86-j1.1 Ω
1060 MHz	1.38-j0.2 Ω	0.80-j0.94 Ω
1090 MHz	1.46-j0.08 Ω	0.74-j0.82 Ω



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TEST CIRCUIT (inches)



- Board Material: Roger Duroid 6006 @ H=25 mils, Er=6.15
- DXF file available upon request

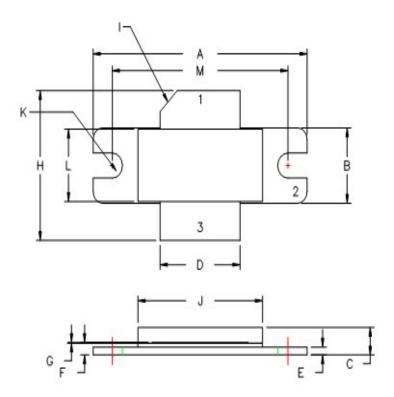
BILL OF MATERIALS

Item	Description	Value
C1	ATC 100A	100pF
C2	ATC 800A	100pF
C3	ATC 100B	100pF
C4	ATC 100B	1nF
C5	ATC 200B	10nF
C6	ATC 200B	100nF
R1	0805	20Ω
R2	0805	2.5Ω



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1011GN-1200V 55-Q03 Package



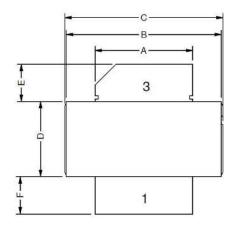
DIM	MILLIMETER	TOL	INCHES	TOL
Α	34.03	.25	1.340	.010
В	9.78	.25	.385	.010
С	3.55	.19	.140	.007
D	12.70	.13	.500	.005
E	1.02	.13	.040	.005
F	1.65	.13	.065	.005
G	0.13	.03	.005	.001
Н	19.43	.76	.765	.030
1	45"	5.	45"	5.
J	19.81	.25	.780	.030
K	3.30 DIA	.13	.130 DIA	.005
L	9.40	.13	.370	.005
М	27.94	MAX	1.100	MAX

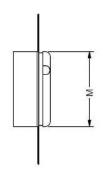
PIN 1 = DRAIN PIN 2 = SOURCE PIN 3 = GATE

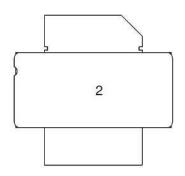


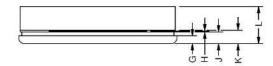
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1011GN-1200V 55-Q03P Package









Dimension	Min(in.)	Max (in.)
A	.495	.505
В	.795	.805
С	.805	.815
D	.380	.390
E	.170	.210
E	.170	.210
G	.035	.045
Н	.003	.006
J	.057	.067
K	.066	.076
L	.18	.20
M	.380	.390

NOTES 1 = GATE 2 = SOURCE 3 = DRAIN



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Revision History

Revision Level / Date	Para. Affected	Description
06 / March 20, 2015	-	Initial Preliminary Release
08 / August 22, 2017	Typical Data	Added Mode-S ELM data and charts
09 / February 25, 2018		Added VEL 55-Q03P packaged device